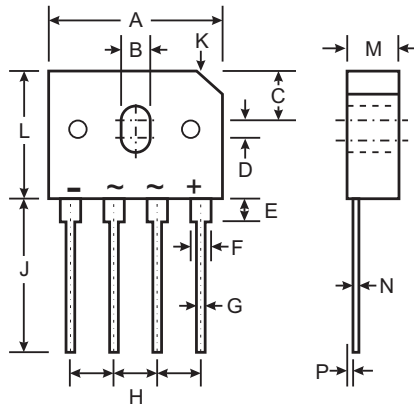


Features

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1500VRMS
- Low Reverse Leakage Current
- Surge Overload Rating to 220A Peak
- Ideal for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E94661
- **Lead Free Finish, RoHS Compliant (Note 4)**

Mechanical Data

- Case: GBU
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish — Bright Tin. Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Mounting: Through Hole for #6 Screw
- Mounting Torque: 5.0 Inch-pounds Maximum
- Ordering Information: See Last Page
- Marking: Date Code and Type Number
- Weight: 6.6 grams (approximate)



GBU		
Dim	Min	Max
A	21.8	22.3
B	3.5	4.1
C	7.4	7.9
D	1.65	2.16
E	2.25	2.75
F	1.95	2.35
G	1.02	1.27
H	4.83	5.33
J	17.5	18.0
K	3.2 X 45°	
L	18.3	18.8
M	3.30	3.56
N	0.46	0.56
P	0.76	1.0
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	GBU 10005	GBU 1001	GBU 1002	GBU 1004	GBU 1006	GBU 1008	GBU 1010	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V _{RWM}								
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Forward Rectified Current (Note 1) @ T _C = 100°C	I _(AV)	10							A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	220							A
Forward Voltage (per element) @ I _F = 5.0A	V _{FM}	1.0							V
Peak Reverse Current @ T _C = 25°C at Rated DC Blocking Voltage @ T _C = 125°C	I _R	5.0 500							μA
I ² t Rating for Fusing (Note 2)	I ² t	200							A ² s
Typical Total Capacitance per Element (Note 3)	C _T	60							pF
Typical Thermal Resistance Junction to Case (Note 1)	R _{θJC}	2.2							°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150							°C

- Notes:
1. Unit mounted on 100 x 100 x 1.6mm copper plate heatsink.
 2. Non-repetitive, for t > 1.0ms and < 8.3ms.
 3. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 4. RoHS revision 13.2.2003. Glass and High temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

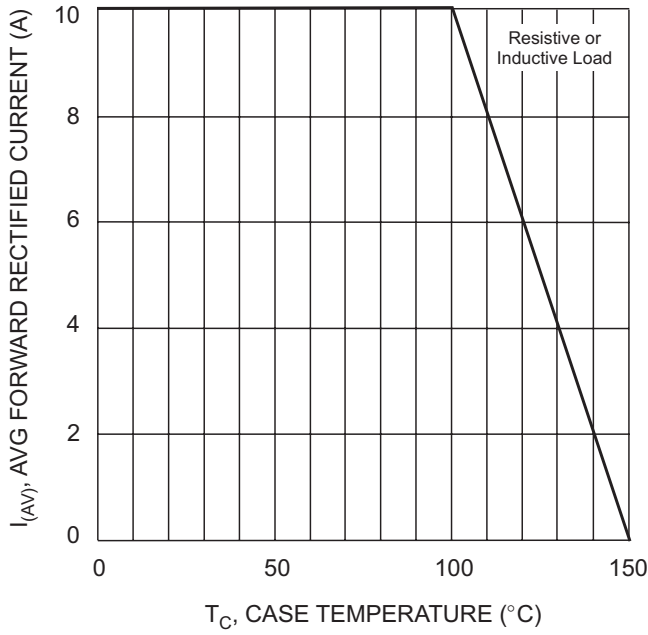


Fig. 1 Forward Current Derating Curve

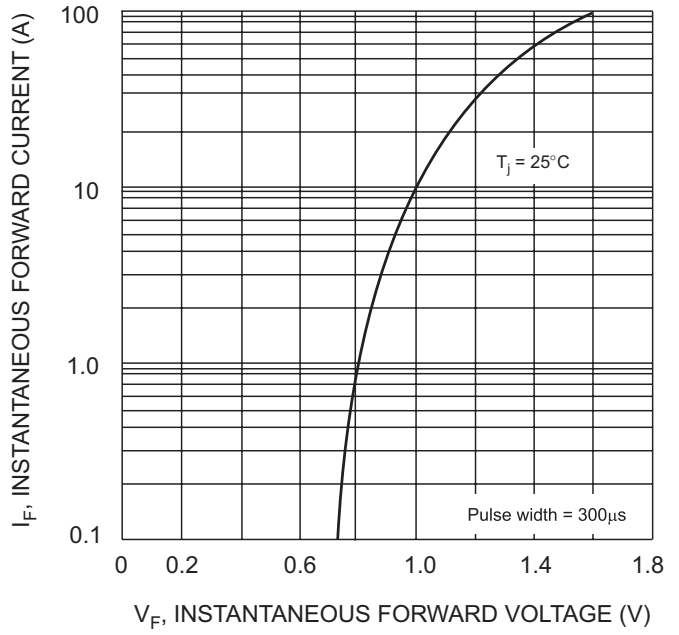


Fig. 2 Typical Forward Characteristics, per element

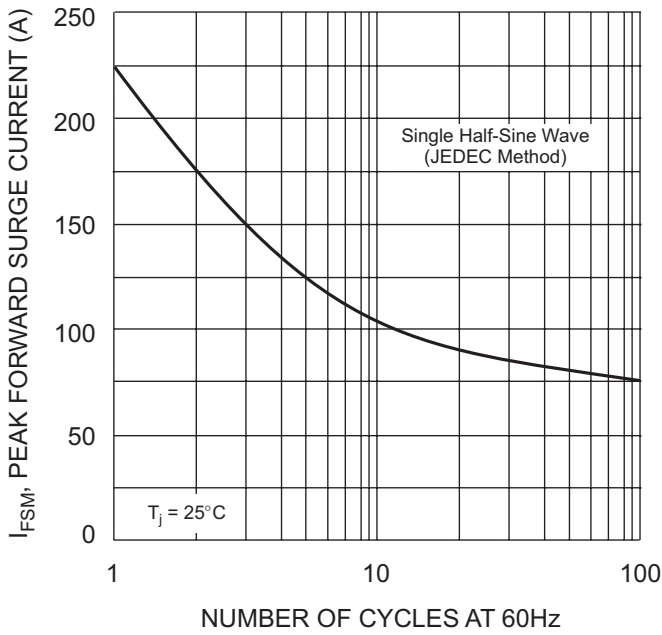


Fig. 3 Maximum Non-Repetitive Surge Current

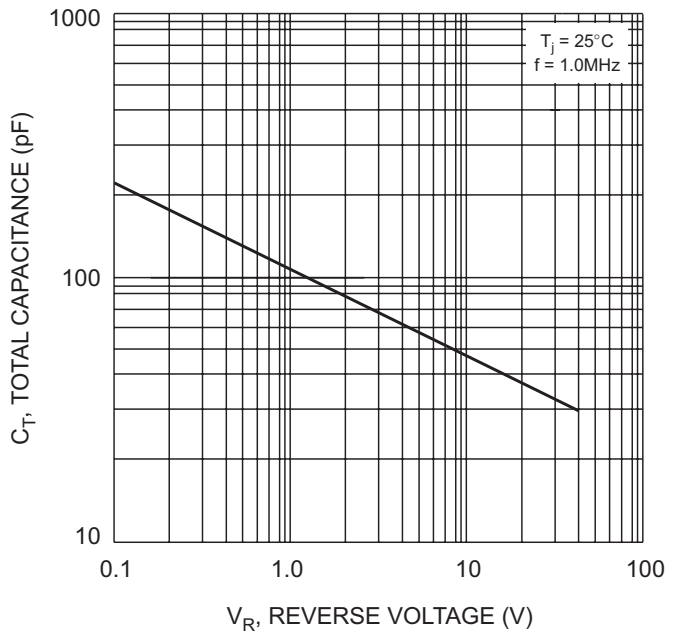


Fig. 4 Typical Total Capacitance, per element

Ordering Information (Note 5)

Device	Packaging	Shipping
GBU10005-GBU1010	GBU	20/Tube

Notes: 5. For packaging details, visit our website at <http://www.diodes.com/datasheets/ap02008.pdf>.